

KYOTO, JAPAN CONFERENCE – CALL for PAPERS

2017 International Symposium on Education and Psychology (ISEP 2017)
April 4–6, 2017, Kyoto, Japan
<http://tw-knowledge.org/isep>

We cordially invite you and your colleagues to participate and submit papers to 2017 International Symposium on Education and Psychology (ISEP 2017) that will be held at International Community House, Kyoto, Japan, on the 4th–6th April 2017. We welcome submissions from all over the world and we encourage you to join us in Kyoto, Japan to share your research and knowledge. To submit abstracts/papers for presentation or participate as an audience member, please visit the conference website for more details. All submissions will be subject to a double-blind review process. All accepted manuscripts will be published in the conference proceedings, under an ISSN reference, on CD-ROM support.

The objectives of the conference are:

1. Provide a platform for the researchers to seek further opinions, comments and suggestions.
2. Contribute knowledge in the field of education and psychology.
3. Provide wider opportunities for participants to interact and create networking.
4. Deliver your research findings to global audiences.
5. Participate in a truly international, interdisciplinary and intercultural event.

The conference venue Kyoto is Japan's capital for more than 1,000 years. Kyoto was the center not only for politics, but religion, philosophy, art, culture, and cuisine. The cherry blossoms (sakura) usually bloom in the last week of March and the first two weeks of April in Kyoto. In an average year, the blooms peak on April 1st in Kyoto. Once they bloom, they are notoriously fickle: sometimes almost all the trees will come into full bloom at the same time and stay in full bloom for a week or even longer. We believe that you will enjoy your stay in Kyoto. If you need any assistance, please feel free to contact us.

<http://tw-knowledge.org/isep> Conference Website:
<http://192.169.244.28/isep2017> Online Submission:
isep.conf@gmail.com Enquiries:
Submission Deadline: December 10, 2016